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James A. Buford, Jr.
R. Lee Murrer, Jr.
Gary H. Ballard
Editors

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Contents

v Conference Committee

SESSION 1 IR SCENE PROJECTORS

- 8356 02 **Spectral shift of infrared LEDs and resistive sources** [8356-01]
M. L. Fedde, H. S. Lowry, J. H. Mansfield, Aerospace Testing Alliance (United States)
- 8356 03 **Contrast analysis for DMD-based IR scene projector** [8356-02]
J. Rentz Dupuis, D. J. Mansur, S. Grant, S. P. Newbry, OPTRA, Inc. (United States)
- 8356 04 **Large-scale silicon photonic infrared scene projector by down conversion** [8356-03]
V. K. Malyutenko, V. Lashkaryov Institute of Semiconductor Physics (Ukraine)
- 8356 05 **Performance of bottom emitting isolated LWIR LED devices for IR scene projection** [8356-04]
N. C. Das, U.S. Army Research Lab. (United States)
- 8356 09 **Development of photonic crystal based large format IR scene projection technology**
[8356-08]
J. A. Wilson, Cyan Systems (United States); B. Burckel, Sandia National Labs. (United States);
J. Caulfield, Cyan Systems (United States); S. Cogan, M. Massie, Nova Teledyne (United
States); R. Rapp, R. Rose, D. Snyder, Air Force Research Lab. (United States)
- 8356 0A **Liquid crystal on silicon (LCOS) devices and their application to scene projection** [8356-09]
T. Ewing, J. Buck, S. Serati, A. Linnenberger, H. Masterson, J. Stockley, Boulder Nonlinear
Systems, Inc. (United States)

SESSION 2 RESISTOR ARRAY PROJECTORS

- 8356 0D **A hybrid approach to non-uniformity correction of large format emitter arrays** [8356-12]
J. LaVeigne, M. Prewarski, G. Franks, S. McHugh, Santa Barbara Infrared, Inc. (United States)
- 8356 0E **Ultra high temperature (UHT) infrared scene projector system development status** [8356-13]
K. Sparkman, J. LaVeigne, S. McHugh, Santa Barbara Infrared, Inc. (United States);
J. Lannon, S. Goodwin, RTI International (United States)
- 8356 0F **Radical rise-time enhancement of a resistive IRSP array** [8356-14]
G. Franks, J. LaVeigne, S. McHugh, Santa Barbara Infrared, Inc. (United States)
- 8356 0G **Design considerations for a high-temperature, high-dynamic range IRSP** [8356-15]
J. LaVeigne, Santa Barbara Infrared, Inc. (United States); B. Sieglinger, MacAulay-Brown, Inc.
(United States)

SESSION 3 FACILITIES, SCENE GENERATION, AND FLIGHT SIMULATORS

- 8356 0K **Scene projection technology development for imaging sensor testing at AEDC** [8356-19]
H. Lowry, M. Fedde, D. Crider, H. Horne, K. Bynum, S. Steely, J. Labello, Aerospace Testing Alliance (United States)
- 8356 0L **Application of scene projection technologies at the AMRDEC SSDD HWIL facilities** [8356-20]
J. P. Gareri, Simulation Technologies, Inc. (United States); G. H. Ballard, J. W. Morris, U.S. Army Aviation & Missile Research, Development and Engineering Ctr. (United States); D. Bunfield, The AEgis Technologies Group, Inc. (United States); D. Saylor, Optical Sciences Corp. (United States)
- 8356 0M **Infrared projector optical system characterisation and its application to nonuniformity correction** [8356-21]
L. Swierkowski, R. A. Joyce, C. L. Christie, Defence Science and Technology Organisation (Australia)
- 8356 0N **Performance parameters in the design of flight motion simulators** [8356-22]
R. W. Mitchell, Ideal Aerosmith, Inc. (United States)
- 8356 0O **Common hardware-in-the-loop framework development** [8356-23]
H. Kim, U.S. Army Aviation & Missile Research, Development and Engineering Ctr. (United States); R. Billings, WideBand Corp. (United States); R. D. Mohlere, Simulation Technologies Inc. (United States); S. G. Moss, The AEgis Technologies Group, Inc. (United States); C. B. Naumann, Optical Sciences Corp. (United States)

Author Index

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- 1 IR Scene Projectors
Heard Lowry, Aerospace Testing Alliance-Arnold Engineering
Development Center (United States)
Robert W. Mitchell, Ideal Aerosmith, Inc. (United States)
Gary H. Ballard, U.S. Army Aviation and Missile Research Development
and Engineering Center (United States)
- 2 Resistor Array Projectors
Raul Fainchtein, The Johns Hopkins University Applied Physics
Laboratory (United States)
David B. Beasley, Optical Sciences Corporation (United States)
James A. Buford, Jr., U.S. Army Aviation and Missile Research
Development and Engineering Center (United States)
Brian K. Woode, Naval Air Warfare Center Aircraft Division
(United States)
- 3 Facilities, Scene Generation, and Flight Simulators
Kevin Fisher, ACUTRONIC Switzerland Ltd. (Switzerland)
Richard M. Robinson, The AEgis Technologies Group, Inc.
(United States)
Leszek Swierkowski, Defence Science and Technology Organisation
(Australia)